

## Electronic Acknowledgement Receipt

<b>EFS ID:</b>	5637949
<b>Application Number:</b>	10756122
<b>International Application Number:</b>	
<b>Confirmation Number:</b>	4554
<b>Title of Invention:</b>	Low dielectric constant film produced from silicon compounds comprising silicon-carbon bond
<b>First Named Inventor/Applicant Name:</b>	Wai-Fan Yau
<b>Customer Number:</b>	44257
<b>Filer:</b>	Keith M. Tackett/Teresa Fish
<b>Filer Authorized By:</b>	Keith M. Tackett
<b>Attorney Docket Number:</b>	AMAT/2592.C7/DSM/LOW K/JW
<b>Receipt Date:</b>	02-JUL-2009
<b>Filing Date:</b>	13-JAN-2004
<b>Time Stamp:</b>	16:18:38
<b>Application Type:</b>	Utility under 35 USC 111(a)

### Payment information:

Submitted with Payment	no
------------------------	----

### File Listing:

Document Number	Document Description	File Name	File Size(Bytes)/ Message Digest	Multi Part /.zip	Pages (if appl.)
1		002592- C7_SIDS_and_Fee_Transmittal. pdf	207222  3a8f860dd1a4c0d4d2e94a77e7b57900a0292a86	yes	5

Multipart Description/PDF files in .zip description					
Document Description			Start	End	
Transmittal Letter			1	2	
Information Disclosure Statement (IDS) Filed (SB/08)			3	4	
Fee Worksheet (PTO-875)			5	5	
Warnings:					
Information:					
2	NPL Documents	BOGART-- Plasma_Enhanced_Chemical_Vapor_Deposition.pdf	439305 6682e0e40e7af9cd70d040528b7e3c3e2515d8b	no	6
Warnings:					
Information:					
3	NPL Documents	KLUMP-- Photo_Induced_Transformation_of_Polysiloxane_Layers.pdf	355174 11b05644c1efc728bf94b8e4f0ca1eed101a3c91	no	4
Warnings:					
Information:					
4	NPL Documents	BoardDecisionDtd09-16-04.pdf	220285 26013764f12511f7596c6da33298ae42074e72c	no	9
Warnings:					
Information:					
5	NPL Documents	BoardDecisionDtd12-23-04.pdf	195363 698be6877160faf3e1e577698ba01f585e843e	no	7
Warnings:					
Information:					
6	NPL Documents	WOLF-- Silicon_Processing_for_the_VLSI_Era.pdf	1381429 584fe16c4e4e68ce7636a3ab84541f138b6459c55	no	16
Warnings:					
Information:					
7	NPL Documents	Prosecution_History_for_USSN_11-877483.pdf	1172097 a67a94e79811e4f7908a8805446c53da13c732f4	no	26
Warnings:					
Information:					
Total Files Size (in bytes):			3970875		

This Acknowledgement Receipt evidences receipt on the noted date by the USPTO of the indicated documents, characterized by the applicant, and including page counts, where applicable. It serves as evidence of receipt similar to a Post Card, as described in MPEP 503.

**New Applications Under 35 U.S.C. 111**

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

**National Stage of an International Application under 35 U.S.C. 371**

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.

**New International Application Filed with the USPTO as a Receiving Office**

If a new international application is being filed and the international application includes the necessary components for an international filing date (see PCT Article 11 and MPEP 1810), a Notification of the International Application Number and of the International Filing Date (Form PCT/RO/105) will be issued in due course, subject to prescriptions concerning national security, and the date shown on this Acknowledgement Receipt will establish the international filing date of the application.